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With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



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## InGaP HBT 2.4 - 2.5 GHz Power Amplifier

PRODUCTION DATA SHEET

#### **DESCRIPTION**

The LX5535 is a power amplifier PA is implemented as a three-stage monolithic microwave integrated output pre-matching.

(HBT) IC (MOCVD). With single low voltage amplifier requirements for supply of 5V, it provides 32 dB power 802.11b/g and WiMAX applications. gain between 2.4-2.5GHz, at a low quiescent current of 120mA.

The output power for EVM(Error optimized for WLAN applications in Vector Magnitude) of 3.5% is 25dBm the 2.4-2.5 GHz frequency range. The (64QAM/54Mbps), where the PA consumes 260mA total DC current.

The LX5535 is available in a 16-pin circuit (MMIC) with active bias and 3mm x 3mm micro-lead package (MLPQ-16L). The compact footprint, The device is manufactured with an low profile, and thermal capability of InGaP/GaAs Heterojunction Bipolar the MLP package makes the LX5535 an process ideal solution for high-gain power

IMPORTANT: For the most current data, consult MICROSEMI's website: http://www.microsemi.com

## **KEY FEATURES**

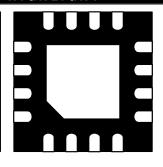
- Advanced InGaP HBT
- 2.4-2.5GHz Operation
- Single-Polarity 3-5V Supply
- Quiescent Current 120mA
- Power Gain 32 dB
- Power for EVM~3.5 % 54Mbps/64QAM: 25dBm
- Total Current 260mA for Pout=25dBm, 802.11g
- 802.11b mask-compliant power: 28dBm
- Total Current 370mA for Pout=+28dBm, 802,11b
- Small Footprint: 3x3mm<sup>2</sup>
- Low Profile: 0.9mm

#### APPLICATIONS

- IEEE 802.11b/g
- IEEE 802.16 WiMAX

## PRODUCT HIGHLIGHT

**MSC** 5535



#### PACKAGE ORDER INFO

Plastic MLPQ  $3\times3$  16 pin LO RoHS Compliant / Pb-free

LX5535LQ

Note: Available in Tape & Reel. Append the letter "TR" to the part number. (i.e. LX5535LQ-TR)



### INFORMATION

Thank you for your interest in Microsemi® Analog Mixed Signal products.

The full data sheet for this device contains proprietary information.

To obtain a copy, please contact your local Microsemi sales representative. The name of your local representative can be obtained at the following link <a href="http://www.microsemi.com/contact/contactfind.asp">http://www.microsemi.com/contact/contactfind.asp</a>

or

Contact us directly by sending an email to:

IPGdatasheets@microsemi.com

Be sure to specify the data sheet you are requesting and include your company name and contact information and or vcard.

We look forward to hearing from you.